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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	2320
Number of Logic Elements/Cells	20880
Total RAM Bits	1622016
Number of I/O	556
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	896-BBGA, FCBGA
Supplier Device Package	896-FCBGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp20-5ff896c

- Execution unit
- Timers
- Debug logic unit

It operates on instructions in a five stage pipeline consisting of a fetch, decode, execute, write-back, and load write-back stage. Most instructions execute in a single cycle, including loads and stores.

Instruction and Data Cache

The embedded PPC405 core provides an instruction cache unit (ICU) and a data cache unit (DCU) that allow concurrent accesses and minimize pipeline stalls. The instruction and data cache array are 16 KB each. Both cache units are two-way set associative. Each way is organized into 256 lines of 32 bytes (eight words). The instruction set provides a rich assortment of cache control instructions, including instructions to read tag information and data arrays.

The PPC405 core accesses external memory through the instruction (ICU) and data cache units (DCU). The cache units each include a 64-bit PLB master interface, cache arrays, and a cache controller. The ICU and DCU handle cache misses as requests over the PLB to another PLB device such as an external bus interface unit. Cache hits are handled as single cycle memory accesses to the instruction and data caches.

Instruction Cache Unit (ICU)

The ICU provides one or two instructions per cycle to the instruction queue over a 64-bit bus. A line buffer (built into the output of the array for manufacturing test) enables the ICU to be accessed only once for every four instructions, to reduce power consumption by the array.

The ICU can forward any or all of the four or eight words of a line fill to the EXU to minimize pipeline stalls caused by cache misses. The ICU aborts speculative fetches abandoned by the EXU, eliminating unnecessary line fills and enabling the ICU to handle the next EXU fetch. Aborting abandoned requests also eliminates unnecessary external bus activity, thereby increasing external bus utilization.

Data Cache Unit (DCU)

The DCU transfers one, two, three, four, or eight bytes per cycle, depending on the number of byte enables presented by the CPU. The DCU contains a single-element command and store data queue to reduce pipeline stalls; this queue enables the DCU to independently process load/store and cache control instructions. Dynamic PLB request prioritization reduces pipeline stalls even further. When the DCU is busy with a low-priority request while a subsequent storage operation requested by the CPU is stalled; the DCU automatically increases the priority of the current request to the PLB.

The DCU provides additional features that allow the programmer to tailor its performance for a given application. The DCU can function in write-back or write-through mode, as controlled by the Data Cache Write-through Register (DCWR) or the Translation Look-aside Buffer (TLB); the cache controller can be tuned for a balance of performance and memory coherency. Write-on-allocate, controlled by the store word on allocate (SWOA) field of the Core Configuration Register 0 (CCR0), can inhibit line fills caused by store misses, to further reduce potential pipeline stalls and unwanted external bus traffic.

Fetch and Decode Logic

The fetch/decode logic maintains a steady flow of instructions to the execution unit by placing up to two instructions in the fetch queue. The fetch queue consists of three buffers: pre-fetch buffer 1 (PFB1), pre-fetch buffer 0 (PFB0), and decode (DCD). The fetch logic ensures that instructions proceed directly to decode when the queue is empty.

Static branch prediction as implemented on the PPC405 core takes advantage of some standard statistical properties of code. Branches with negative address displacement are by default assumed taken. Branches that do not test the condition or count registers are also predicted as taken. The PPC405 core bases branch prediction upon these default conditions when a branch is not resolved and speculatively fetches along the predicted path. The default prediction can be overridden by software at assembly or compile time.

Branches are examined in the decode and pre-fetch buffer 0 fetch queue stages. Two branch instructions can be handled simultaneously. If the branch in decode is not taken, the fetch logic fetches along the predicted path of the branch instruction in pre-fetch buffer 0. If the branch in decode is taken, the fetch logic ignores the branch instruction in pre-fetch buffer 0.

Execution Unit

The embedded PPC405 core has a single issue execution unit (EXU) containing the register file, arithmetic logic unit (ALU), and the multiply-accumulate (MAC) unit. The execution unit performs all 32-bit PowerPC integer instructions in hardware.

The register file is comprised of thirty-two 32-bit general purpose registers (GPR), which are accessed with three read ports and two write ports. During the decode stage, data is read out of the GPRs and fed to the execution unit. Likewise, during the write-back stage, results are written to the GPR. The use of the five ports on the register file enables either a load or a store operation to execute in parallel with an ALU operation.

Memory Management Unit (MMU)

The embedded PPC405 core has a 4 GB address space, which is presented as a flat address space.

The MMU provides address translation, protection functions, and storage attribute control for embedded applications. The MMU supports demand-paged virtual memory and other management schemes that require precise control of logical-to-physical address mapping and flexible

Virtex-II Pro Pin-to-Pin Output Parameter Guidelines

All devices are 100% functionally tested. Listed below are representative values for typical pin locations and normal clock loading. Values are expressed in nanoseconds unless otherwise noted.

Global Clock Input to Output Delay for LVCMOS25, 12 mA, Fast Slew Rate, *With* DCM

Table 53: **Global Clock Input to Output Delay for LVCMOS25, 12 mA, Fast Slew Rate, *With* DCM**

			Speed Grade			
Description	**Symbol**	**Device**	**-7**	**-6**	**-5**	**Units**
LVCMOS25 Global Clock Input to Output Delay using Output Flip-flop, 12 mA, Fast Slew Rate, *with* DCM. For data *output* with different standards, adjust the delays with the values shown in IOB Output Switching Characteristics Standard Adjustments, page 28.						
Global Clock and OFF with DCM	$T_{ICKOFDCM}$	XC2VP2	1.55	1.59	1.62	ns
		XC2VP4	1.58	1.61	1.65	ns
		XC2VP7	1.63	1.68	1.72	ns
		XC2VP20	1.68	1.74	1.79	ns
		XC2VPX20	1.68	1.74	1.79	ns
		XC2VP30	1.68	1.75	1.80	ns
		XC2VP40	1.71	1.86	1.92	ns
		XC2VP50	1.80	2.00	2.07	ns
		XC2VP70	1.87	2.07	2.24	ns
		XC2VPX70	1.87	2.07	2.24	ns
		XC2VP100	N/A	2.38	2.45	ns

Notes:
1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. Output timing is measured at 50% V_{CC} threshold with test setup shown in Figure 6. For other I/O standards, see Table 40.
3. DCM output jitter is already included in the timing calculation.

Output Clock Jitter

Table 59: **Output Clock Jitter**

Description	Symbol	Constraints	Speed Grade			Units
			–7	–6	–5	
Clock Synthesis Period Jitter						
CLK0	CLKOUT_PER_JITT_0		±100	±100	±100	ps
CLK90	CLKOUT_PER_JITT_90		±150	±150	±150	ps
CLK180	CLKOUT_PER_JITT_180		±150	±150	±150	ps
CLK270	CLKOUT_PER_JITT_270		±150	±150	±150	ps
CLK2X, CLK2X180	CLKOUT_PER_JITT_2X		±200	±200	±200	ps
CLKDV (integer division)	CLKOUT_PER_JITT_DV1		±150	±150	±150	ps
CLKDV (non-integer division)	CLKOUT_PER_JITT_DV2		±300	±300	±300	ps
CLKFX, CLKFX180	CLKOUT_PER_JITT_FX		Note (1)	Note (1)	Note (1)	ps

Notes:
1. Use the **Jitter Calculator** on the Xilinx website (http://www.xilinx.com/applications/web_ds_v2/jitter_calc.htm) for CLKFX and CLKFX180 output jitter.

Output Clock Phase Alignment

Table 60: **Output Clock Phase Alignment**

Description	Symbol	Constraints	Speed Grade			Units
			–7	–6	–5	
Phase Offset Between CLKIN and CLKFB						
CLKIN/CLKFB	CLKIN_CLKFB_PHASE		±50	±50	±50	ps
Phase Offset Between Any DCM Outputs						
All CLK* outputs	CLKOUT_PHASE		±140	±140	±140	ps
Duty Cycle Precision						
DLL outputs(1)	CLKOUT_DUTY_CYCLE_DLL(2)		±150	±150	±150	ps
CLKFX outputs	CLKOUT_DUTY_CYCLE_FX		±100	±100	±100	ps

Notes:
1. “DLL outputs” is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. CLKOUT_DUTY_CYCLE_DLL applies to the 1X clock outputs (CLK0, CLK90, CLK180, and CLK270) only if DUTY_CYCLE_CORRECTION = TRUE.
3. Specification also applies to PSCLK.

Miscellaneous Timing Parameters

Table 61: **Miscellaneous Timing Parameters**

Description	Symbol	Constraints F_{CLKIN}	Speed Grade			Units
			-7	-6	-5	
Time Required to Achieve LOCK						
Using DLL outputs(1)	LOCK_DLL:					
	LOCK_DLL_60	> 60MHz	20.00	20.00	20.00	us
	LOCK_DLL_50_60	50 - 60 MHz	25.00	25.00	25.00	us
	LOCK_DLL_40_50	40 - 50 MHz	50.00	50.00	50.00	us
	LOCK_DLL_30_40	30 - 40 MHz	90.00	90.00	90.00	us
	LOCK_DLL_24_30	24 - 30 MHz	120.00	120.00	120.00	us
Using CLKFX outputs	LOCK_FX_MIN		10.00	10.00	10.00	ms
	LOCK_FX_MAX		10.00	10.00	10.00	ms
Additional lock time with fine phase shifting	LOCK_DLL_FINE_SHIFT		50.00	50.00	50.00	us
Fine Phase Shifting						
Absolute shifting range	FINE_SHIFT_RANGE		10.00	10.00	10.00	ns
Delay Lines						
Tap delay resolution	DCM_TAP_MIN		30.00	30.00	30.00	ps
	DCM_TAP_MAX		50.00	50.00	50.00	ps

Notes:
1. “DLL outputs” is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.

Frequency Synthesis

Table 62: **Frequency Synthesis**

Attribute	Min	Max
CLKFX_MULTIPLY	2	32
CLKFX_DIVIDE	1	32

Parameter Cross-Reference

Table 63: **Parameter Cross-Reference**

Libraries Guide	Data Sheet
DLL_CLKOUT_{MIN|MAX}_LF	CLKOUT_FREQ_{1X|2X|DV}_LF
DFS_CLKOUT_{MIN|MAX}_LF	CLKOUT_FREQ_FX_LF
DLL_CLKIN_{MIN|MAX}_LF	CLKIN_FREQ_DLL_LF
DFS_CLKIN_{MIN|MAX}_LF	CLKIN_FREQ_FX_LF
DLL_CLKOUT_{MIN|MAX}_HF	CLKOUT_FREQ_{1X|DV}_HF
DFS_CLKOUT_{MIN|MAX}_HF	CLKOUT_FREQ_FX_HF
DLL_CLKIN_{MIN|MAX}_HF	CLKIN_FREQ_DLL_HF
DFS_CLKIN_{MIN|MAX}_HF	CLKIN_FREQ_FX_HF

Virtex-II Pro Receiver Data-Valid Window (R_X)

R_X is the required minimum aggregate valid data period for a source-synchronous data bus at the pins of the device and is calculated as follows:

$$R_X = [TSAMP^{(1)} + TCKSKEW^{(2)} + TPKGSKEW^{(3)}]$$

Notes:

1. This parameter indicates the total sampling error of Virtex-II Pro DDR input registers across voltage, temperature, and process. The characterization methodology uses the DCM to capture the DDR input registers' edges of operation. These measurements include:
   - CLK0 and CLK180 DCM jitter in a quiet system
   - Worst-case duty-cycle distortion
   - DCM accuracy (phase offset)
   - DCM phase shift resolution.

   These measurements do not include package or clock tree skew.
2. This value represents the worst-case clock-tree skew observable between sequential I/O elements. Significantly less clock-tree skew exists for I/O registers that are close to each other and fed by the same or adjacent clock-tree branches. Use the Xilinx FPGA_Editor and Timing Analyzer tools to evaluate clock skew specific to your application.
3. These values represent the worst-case skew between any two balls of the package: shortest flight time to longest flight time from Pad to Ball.

Revision History

This section records the change history for this module of the data sheet.

Date	Version	Revision
01/31/02	1.0	Initial Xilinx release.
06/17/02	2.0	• Added new Virtex-II Pro family members. • Added timing parameters from speedsfile **v1.62**. • Added Table 46, Pipelined Multiplier Switching Characteristics. • Added 3.3V-vs-2.5V table entries for some parameters.
09/03/02	2.1	• Added Source-Synchronous Switching Characteristics section. • Added absolute max ratings for 3.3V-vs-2.5V parameters in Table 1. • Added recommended operating conditions for V_{IN} and RocketIO footnote to Table 2. • Updated SSTL2 values in Table 6. Added SSTL18 values: Table 6, Table 39, Table 32. [Table 32 removed in v2.8.] • Added Table 10, which contains LVPECL DC specifications.
09/27/02	2.2	Added section General Power Supply Requirements.
11/20/02	2.3	Updated parametric information in: • Table 1: Increase Absolute Max Rating for V_{CCO}, V_{REF}, V_{IN}, and V_{TS} from 3.6V to 3.75V. Delete cautionary footnotes related to voltage overshoot/undershoot. • Table 2: Delete V_{CCO} specifications for 2.5V and below operation. Delete footnote referencing special information for 3.3V operation. Add footnote for PCI/PCI-X. • Table 3: Add I_{BATT}. Delete I_L specifications for 2.5V and below operation. • Table 4: Add Typical Quiescent Supply Currents for XC2VP4 and XC2VP7 only • Table 6: Correct I_{OL} and I_{OH} for SSTL2 I. Add rows for LVTTL, LVCMOS33, and PCI-X. Correct max V_{IH} from V_{CCO} to 3.6V. • Table 7: Correct Min/Max V_{OD}, V_{OCM}, and V_{ICM} • Table 10: Reformat LVPECL DC Specifications to match Virtex-II data sheet format • Table 12: Correct parameter name from Differential Output Voltage to Single-Ended Output Voltage Swing. • Table 16: Add CPMC405CLOCK max frequencies • Table 27: Add footnote regarding serial data rate limitation in -5 part. • Table 39: Add rows for LVTTL, LVCMOS33, and PCI-X. • Table 32: Add LVTTL, LVCMOS33, and PCI-X. Correct all capacitive load values (except PCI/PCI-X) to 0 pF. [Table 32 removed in v2.8.] • Table 51: Correct CCLK max frequencies
11/25/02	2.4	Table 1: Correct lower limit of voltage range of V_{IN} and V_{TS} from –0.3V to –0.5V for 3.3V.

Table 6: **FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
1	IO_L07P_1	F14			
1	IO_L06N_1	C15			
1	IO_L06P_1	D15			
1	IO_L05_1/No_Pair	E15			
1	IO_L03N_1/VREF_1	C16			
1	IO_L03P_1	D16			
1	IO_L02N_1	E16			
1	IO_L02P_1	E17			
1	IO_L01N_1/VRP_1	D17			
1	IO_L01P_1/VRN_1	D18			
2	IO_L01N_2/VRP_2	C21			
2	IO_L01P_2/VRN_2	C22			
2	IO_L02N_2	D21			
2	IO_L02P_2	D22			
2	IO_L03N_2	E19			
2	IO_L03P_2	E20			
2	IO_L04N_2/VREF_2	E21			
2	IO_L04P_2	E22			
2	IO_L06N_2	F19			
2	IO_L06P_2	F20			
2	IO_L43N_2	F21	NC		
2	IO_L43P_2	F22	NC		
2	IO_L46N_2/VREF_2	F18	NC		
2	IO_L46P_2	G18	NC		
2	IO_L48N_2	G19	NC		
2	IO_L48P_2	G20	NC		
2	IO_L49N_2	G21	NC		
2	IO_L49P_2	G22	NC		
2	IO_L50N_2	H19	NC		
2	IO_L50P_2	H20	NC		
2	IO_L52N_2/VREF_2	H21	NC		
2	IO_L52P_2	H22	NC		
2	IO_L54N_2	H18	NC		
2	IO_L54P_2	J17	NC		
2	IO_L55N_2	J19	NC		
2	IO_L55P_2	J20	NC		

Table 7: **FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
2	IO_L31P_2	F26			
2	IO_L32N_2	G22			
2	IO_L32P_2	H22			
2	IO_L34N_2/VREF_2	G23			
2	IO_L34P_2	G24			
2	IO_L36N_2	G25			
2	IO_L36P_2	G26			
2	IO_L37N_2	H20			
2	IO_L37P_2	H21			
2	IO_L38N_2	H25			
2	IO_L38P_2	H26			
2	IO_L40N_2/VREF_2	J19			
2	IO_L40P_2	J20			
2	IO_L42N_2	J21			
2	IO_L42P_2	J22			
2	IO_L43N_2	J23			
2	IO_L43P_2	J24			
2	IO_L44N_2	J25			
2	IO_L44P_2	J26			
2	IO_L46N_2/VREF_2	K19			
2	IO_L46P_2	L19			
2	IO_L48N_2	K22			
2	IO_L48P_2	K23			
2	IO_L49N_2	K24			
2	IO_L49P_2	L24			
2	IO_L50N_2	K25			
2	IO_L50P_2	K26			
2	IO_L52N_2/VREF_2	L20			
2	IO_L52P_2	M20			
2	IO_L54N_2	L21			
2	IO_L54P_2	L22			
2	IO_L55N_2	L25			
2	IO_L55P_2	L26			
2	IO_L56N_2	M18			
2	IO_L56P_2	M19			

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
3	IO_L58P_3	W6				
3	IO_L57N_3/VREF_3	Y3				
3	IO_L57P_3	Y4				
3	IO_L56N_3	W7				
3	IO_L56P_3	W8				
3	IO_L55N_3	Y6				
3	IO_L55P_3	Y7				
3	IO_L54N_3	AA2				
3	IO_L54P_3	AB2				
3	IO_L53N_3	W9				
3	IO_L53P_3	W10				
3	IO_L52N_3	AA3				
3	IO_L52P_3	AA4				
3	IO_L51N_3/VREF_3	AB1				
3	IO_L51P_3	AC1				
3	IO_L50N_3	Y9				
3	IO_L50P_3	Y10				
3	IO_L49N_3	AA5				
3	IO_L49P_3	AA6				
3	IO_L48N_3	AB3				
3	IO_L48P_3	AB4				
3	IO_L47N_3	AA7				
3	IO_L47P_3	AA8				
3	IO_L46N_3	AB5				
3	IO_L46P_3	AB6				
3	IO_L45N_3/VREF_3	AC2				
3	IO_L45P_3	AD2				
3	IO_L44N_3	AA9				
3	IO_L44P_3	AA10				
3	IO_L43N_3	AC3				
3	IO_L43P_3	AC4				
3	IO_L42N_3	AD1				
3	IO_L42P_3	AE1				
3	IO_L41N_3	AB7				
3	IO_L41P_3	AB8				
3	IO_L40N_3	AC6				
3	IO_L40P_3	AC7				
3	IO_L39N_3/VREF_3	AD3				

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
7	IO_L86N_7	U25				
7	IO_L85P_7	T32				
7	IO_L85N_7	T31				
7	IO_L60P_7	T30				
7	IO_L60N_7	T29				
7	IO_L59P_7	T28				
7	IO_L59N_7	T27				
7	IO_L58P_7	T33				
7	IO_L58N_7/VREF_7	R33				
7	IO_L57P_7	R32				
7	IO_L57N_7	R31				
7	IO_L56P_7	T26				
7	IO_L56N_7	T25				
7	IO_L55P_7	R34				
7	IO_L55N_7	P34				
7	IO_L54P_7	R29				
7	IO_L54N_7	R28				
7	IO_L53P_7	U24				
7	IO_L53N_7	T24				
7	IO_L52P_7	P32				
7	IO_L52N_7/VREF_7	P31				
7	IO_L51P_7	P30				
7	IO_L51N_7	P29				
7	IO_L50P_7	R26				
7	IO_L50N_7	R25				
7	IO_L49P_7	P33				
7	IO_L49N_7	N33				
7	IO_L48P_7	N32				
7	IO_L48N_7	N31				
7	IO_L47P_7	P28				
7	IO_L47N_7	P27				
7	IO_L46P_7	N34				
7	IO_L46N_7/VREF_7	M34				
7	IO_L45P_7	N30				
7	IO_L45N_7	N29				
7	IO_L44P_7	P26				
7	IO_L44N_7	P25				
7	IO_L43P_7	M32				

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
3	IO_L36N_3	AE4		
3	IO_L36P_3	AF4		
3	IO_L35N_3	AC10		
3	IO_L35P_3	AD10		
3	IO_L34N_3	AE1		
3	IO_L34P_3	AE2		
3	IO_L33N_3/VREF_3	AF6		
3	IO_L33P_3	AF7		
3	IO_L32N_3	AC8		
3	IO_L32P_3	AC9		
3	IO_L31N_3	AF2		
3	IO_L31P_3	AF3		
3	IO_L30N_3	AG5		
3	IO_L30P_3	AG6		
3	IO_L29N_3	AD9		
3	IO_L29P_3	AE9		
3	IO_L28N_3	AG4		
3	IO_L28P_3	AH3		
3	IO_L27N_3/VREF_3	AG2		
3	IO_L27P_3	AG3		
3	IO_L26N_3	AD7		
3	IO_L26P_3	AE7		
3	IO_L25N_3	AH6		
3	IO_L25P_3	AH7		
3	IO_L24N_3	AH5		
3	IO_L24P_3	AJ5		
3	IO_L23N_3	AE8		
3	IO_L23P_3	AF8		
3	IO_L22N_3	AH1		
3	IO_L22P_3	AH2		
3	IO_L21N_3/VREF_3	AJ6		
3	IO_L21P_3	AK6		
3	IO_L20N_3	AG7		
3	IO_L20P_3	AG8		
3	IO_L19N_3	AJ3		
3	IO_L19P_3	AJ4		
3	IO_L18N_3	AJ1		
3	IO_L18P_3	AJ2		

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
2	IO_L30N_2	N6		
2	IO_L30P_2	N7		
2	IO_L31N_2	M4		
2	IO_L31P_2	N5		
2	IO_L32N_2	R11		
2	IO_L32P_2	R12		
2	IO_L33N_2	N1		
2	IO_L33P_2	N2		
2	IO_L34N_2/VREF_2	P6		
2	IO_L34P_2	P7		
2	IO_L35N_2	R13		
2	IO_L35P_2	T13		
2	IO_L36N_2	P4		
2	IO_L36P_2	P5		
2	IO_L37N_2	P3		
2	IO_L37P_2	N3		
2	IO_L38N_2	T10		
2	IO_L38P_2	T11		
2	IO_L39N_2	P1		
2	IO_L39P_2	P2		
2	IO_L40N_2/VREF_2	R7		
2	IO_L40P_2	R8		
2	IO_L41N_2	T12		
2	IO_L41P_2	U12		
2	IO_L42N_2	R5		
2	IO_L42P_2	R6		
2	IO_L43N_2	R3		
2	IO_L43P_2	R4		
2	IO_L44N_2	U8		
2	IO_L44P_2	T8		
2	IO_L45N_2	R1		
2	IO_L45P_2	R2		
2	IO_L46N_2/VREF_2	T6		
2	IO_L46P_2	T7		
2	IO_L47N_2	U9		
2	IO_L47P_2	U10		
2	IO_L48N_2	T2		
2	IO_L48P_2	T3		

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
6	IO_L04P_6	AR33		
6	IO_L04N_6	AP33		
6	IO_L05P_6	AM32		
6	IO_L05N_6	AL31		
6	IO_L06P_6	AT34		
6	IO_L06N_6	AR34		
6	IO_L73P_6	AU35	NC	
6	IO_L73N_6	AT35	NC	
6	IO_L75P_6	AT38	NC	
6	IO_L75N_6/VREF_6	AT39	NC	
6	IO_L76P_6	AR37	NC	
6	IO_L76N_6	AR38	NC	
6	IO_L78P_6	AP38	NC	
6	IO_L78N_6	AP39	NC	
6	IO_L79P_6	AP36	NC	
6	IO_L79N_6	AP37	NC	
6	IO_L81P_6	AP35	NC	
6	IO_L81N_6/VREF_6	AN35	NC	
6	IO_L82P_6	AN38	NC	
6	IO_L82N_6	AN39	NC	
6	IO_L84P_6	AN36	NC	
6	IO_L84N_6	AN37	NC	
6	IO_L07P_6	AN33		
6	IO_L07N_6	AN34		
6	IO_L08P_6	AK31		
6	IO_L08N_6	AK32		
6	IO_L09P_6	AM37		
6	IO_L09N_6/VREF_6	AM38		
6	IO_L10P_6	AM36		
6	IO_L10N_6	AL35		
6	IO_L11P_6	AJ31		
6	IO_L11N_6	AH30		
6	IO_L12P_6	AM33		
6	IO_L12N_6	AM34		
6	IO_L13P_6	AL38		
6	IO_L13N_6	AL39		
6	IO_L14P_6	AH29		
6	IO_L14N_6	AG29		

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
7	VCCO_7	P27		
7	VCCO_7	W26		
7	VCCO_7	V26		
7	VCCO_7	U26		
7	VCCO_7	T26		
7	VCCO_7	R26		
6	VCCO_6	AR39		
6	VCCO_6	AC37		
6	VCCO_6	AR36		
6	VCCO_6	AL36		
6	VCCO_6	AG36		
6	VCCO_6	AC33		
6	VCCO_6	AP32		
6	VCCO_6	AL32		
6	VCCO_6	AG32		
6	VCCO_6	AC29		
6	VCCO_6	AG28		
6	VCCO_6	AF27		
6	VCCO_6	AE26		
6	VCCO_6	AD26		
6	VCCO_6	AC26		
6	VCCO_6	AB26		
6	VCCO_6	AA26		
6	VCCO_6	Y26		
5	VCCO_5	AP27		
5	VCCO_5	AK27		
5	VCCO_5	AG26		
5	VCCO_5	AG25		
5	VCCO_5	AF25		
5	VCCO_5	AG24		
5	VCCO_5	AF24		
5	VCCO_5	AP23		
5	VCCO_5	AK23		
5	VCCO_5	AF23		
5	VCCO_5	AF22		
5	VCCO_5	AF21		
4	VCCO_4	AF19		
4	VCCO_4	AF18		

FF1704 Flip-Chip Fine-Pitch BGA Package

As shown in Table 13, XC2VP70 and XC2VP100 Virtex-II Pro devices are available in the FF1704 flip-chip fine-pitch BGA package. Following this table are the FF1704 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch).

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
0	IO_L01N_0/VRP_0		G34		
0	IO_L01P_0/VRN_0		H34		
0	IO_L02N_0		F34		
0	IO_L02P_0		E34		
0	IO_L03N_0		C34		
0	IO_L03P_0/VREF_0		D34		
0	IO_L05_0/No_Pair		K32		
0	IO_L06N_0		H33		
0	IO_L06P_0		J33		
0	IO_L07N_0		F33		
0	IO_L07P_0		G33		
0	IO_L08N_0		E33		
0	IO_L08P_0		D33		
0	IO_L09N_0		H32		
0	IO_L09P_0/VREF_0		J32		
0	IO_L19N_0		E32		
0	IO_L19P_0		F32		
0	IO_L20N_0		C33		
0	IO_L20P_0		C32		
0	IO_L21N_0		K31		
0	IO_L21P_0		L31		
0	IO_L25N_0		H31		
0	IO_L25P_0		J31		
0	IO_L26N_0		G31		
0	IO_L26P_0		F31		
0	IO_L27N_0		D31		
0	IO_L27P_0/VREF_0		E31		
0	IO_L28N_0		L30		
0	IO_L28P_0		M30		
0	IO_L29N_0		J30		
0	IO_L29P_0		K30		
0	IO_L30N_0		G30		
0	IO_L30P_0		H30		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
4	IO_L09N_4		AR11		
4	IO_L09P_4/VREF_4		AP11		
4	IO_L19N_4		AV11		
4	IO_L19P_4		AU11		
4	IO_L20N_4		AY10		
4	IO_L20P_4		AY11		
4	IO_L21N_4		AN12		
4	IO_L21P_4		AM12		
4	IO_L25N_4		AR12		
4	IO_L25P_4		AP12		
4	IO_L26N_4		AT12		
4	IO_L26P_4		AU12		
4	IO_L27N_4		AW12		
4	IO_L27P_4/VREF_4		AV12		
4	IO_L28N_4		AM13		
4	IO_L28P_4		AL13		
4	IO_L29N_4		AP13		
4	IO_L29P_4		AN13		
4	IO_L30N_4		AT13		
4	IO_L30P_4		AR13		
4	IO_L34N_4		AV13		
4	IO_L34P_4		AU13		
4	IO_L35N_4		AW13		
4	IO_L35P_4		AY13		
4	IO_L36N_4		AL15		
4	IO_L36P_4/VREF_4		AL14		
4	IO_L78N_4		AN14	NC	
4	IO_L78P_4		AM14	NC	
4	IO_L83_4/No_Pair		AR14	NC	
4	IO_L84N_4		AU14	NC	
4	IO_L84P_4		AT14	NC	
4	IO_L85N_4		AW14	NC	
4	IO_L85P_4		AV14	NC	
4	IO_L86N_4		AM15	NC	
4	IO_L86P_4		AN15	NC	
4	IO_L87N_4		AR15	NC	

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
5	IO_L37N_5		AU28		
5	IO_L37P_5		AV28		
5	IO_L87N_5/VREF_5		AP28	NC	
5	IO_L87P_5		AR28	NC	
5	IO_L86N_5		AN28	NC	
5	IO_L86P_5		AM28	NC	
5	IO_L85N_5		AV29	NC	
5	IO_L85P_5		AW29	NC	
5	IO_L84N_5		AT29	NC	
5	IO_L84P_5		AU29	NC	
5	IO_L83_5/No_Pair		AR29	NC	
5	IO_L78N_5		AM29	NC	
5	IO_L78P_5		AN29	NC	
5	IO_L36N_5/VREF_5		AL29		
5	IO_L36P_5		AL28		
5	IO_L35N_5		AY30		
5	IO_L35P_5		AW30		
5	IO_L34N_5		AU30		
5	IO_L34P_5		AV30		
5	IO_L30N_5		AR30		
5	IO_L30P_5		AT30		
5	IO_L29N_5		AN30		
5	IO_L29P_5		AP30		
5	IO_L28N_5		AL30		
5	IO_L28P_5		AM30		
5	IO_L27N_5/VREF_5		AV31		
5	IO_L27P_5		AW31		
5	IO_L26N_5		AU31		
5	IO_L26P_5		AT31		
5	IO_L25N_5		AP31		
5	IO_L25P_5		AR31		
5	IO_L21N_5		AM31		
5	IO_L21P_5		AN31		
5	IO_L20N_5		AY32		
5	IO_L20P_5		AY33		
5	IO_L19N_5		AU32		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	GND		AE19		
N/A	GND		AE18		
N/A	GND		AE17		
N/A	GND		AE9		
N/A	GND		AE6		
N/A	GND		AF25		
N/A	GND		AF24		
N/A	GND		AF23		
N/A	GND		AF22		
N/A	GND		AF21		
N/A	GND		AF20		
N/A	GND		AF19		
N/A	GND		AF18		
N/A	GND		AG42		
N/A	GND		AG1		
N/A	GND		AH39		
N/A	GND		AH36		
N/A	GND		AH7		
N/A	GND		AH4		
N/A	GND		AL42		
N/A	GND		AL1		
N/A	GND		AM22		
N/A	GND		AM21		
N/A	GND		AN39		
N/A	GND		AN4		
N/A	GND		AP34		
N/A	GND		AP9		
N/A	GND		AR42		
N/A	GND		AR35		
N/A	GND		AR22		
N/A	GND		AR21		
N/A	GND		AR8		
N/A	GND		AR1		
N/A	GND		AT36		
N/A	GND		AT7		
N/A	GND		AU37		

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
4	IO_L58P_4	AW19	
4	IO_L59N_4	AP19	
4	IO_L59P_4	AN19	
4	IO_L60N_4	BB19	
4	IO_L60P_4	BA19	
4	IO_L64N_4	AU20	
4	IO_L64P_4	AT20	
4	IO_L65N_4	AL21	
4	IO_L65P_4	AL20	
4	IO_L66N_4	BA20	
4	IO_L66P_4/VREF_4	AY20	
4	IO_L67N_4	AR21	
4	IO_L67P_4	AP21	
4	IO_L68N_4	AN20	
4	IO_L68P_4	AM20	
4	IO_L69N_4	AU21	
4	IO_L69P_4/VREF_4	AT21	
4	IO_L73N_4	AW21	
4	IO_L73P_4	AV21	
4	IO_L74N_4/GCLK3S	AN21	
4	IO_L74P_4/GCLK2P	AM21	
4	IO_L75N_4/GCLK1S	BA21	
4	IO_L75P_4/GCLK0P	AY21	
5	IO_L75N_5/GCLK7S	AY22	
5	IO_L75P_5/GCLK6P	BA22	
5	IO_L74N_5/GCLK5S	AM22	
5	IO_L74P_5/GCLK4P	AN22	
5	IO_L73N_5	AV22	
5	IO_L73P_5	AW22	
5	IO_L69N_5/VREF_5	AT22	
5	IO_L69P_5	AU22	
5	IO_L68N_5	AM23	
5	IO_L68P_5	AN23	
5	IO_L67N_5	AP22	
5	IO_L67P_5	AR22	
5	IO_L66N_5/VREF_5	AY23	

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
6	IO_L02P_6	BA34	
6	IO_L02N_6	AY34	
6	IO_L03P_6	BB37	
6	IO_L03N_6/VREF_6	BA37	
6	IO_L04P_6	BB36	
6	IO_L04N_6	BA36	
6	IO_L05P_6	AW34	
6	IO_L05N_6	AW35	
6	IO_L06P_6	BB35	
6	IO_L06N_6	BA35	
6	IO_L73P_6	BA38	
6	IO_L73N_6	AY38	
6	IO_L74P_6	AU34	
6	IO_L74N_6	AT34	
6	IO_L75P_6	AY39	
6	IO_L75N_6/VREF_6	AY40	
6	IO_L76P_6	AY37	
6	IO_L76N_6	AW36	
6	IO_L77P_6	AR34	
6	IO_L77N_6	AR35	
6	IO_L78P_6	AY35	
6	IO_L78N_6	AY36	
6	IO_L79P_6	AW41	
6	IO_L79N_6	AW42	
6	IO_L80P_6	AP35	
6	IO_L80N_6	AN34	
6	IO_L81P_6	AW40	
6	IO_L81N_6/VREF_6	AV40	
6	IO_L82P_6	AW39	
6	IO_L82N_6	AV39	
6	IO_L83P_6	AM34	
6	IO_L83N_6	AM35	
6	IO_L84P_6	AW38	
6	IO_L84N_6	AV37	
6	IO_L61P_6	AV41	
6	IO_L61N_6	AU40	
6	IO_L62P_6	AL34	

Date	Version	Revision
11/17/04	4.1	• Table 4: Added requirement to V_{BATT} to connect pin to V_{CCAUX} or GND if battery is not used.
03/01/05	4.2	• Table 3: Corrected number of Differential I/O Pairs for XC2VP30-FF1152 from 340 to 316. • Table 4: Changed Direction for User I/O pins (IO_LXXY_#) from “Input/Output” to “Input/Output/Bidirectional”.
06/20/05	4.3	*No changes in Module 4 for this revision.*
09/15/05	4.4	*No changes in Module 4 for this revision.*
10/10/05	4.5	*No changes in Module 4 for this revision.*
03/05/07	4.6	• Figure 2, page 29: Corrected NOTE 3. • Figure 7, page 161: Updated with drawing showing correct heat sink profile and detail.
11/05/07	4.7	Updated copyright notice and legal disclaimer.
06/21/11	5.0	Added *Product Not Recommended for New Designs* banner. Updated Figure 3, page 50, with the newest FG676/FGG676 mechanical drawing.

Notice of Disclaimer

Virtex-II Pro Data Sheet

The Virtex-II Pro Data Sheet contains the following modules:

- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Introduction and Overview (Module 1)
- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Functional Description (Module 2)
- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: DC and Switching Characteristics (Module 3)
- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Pinout Information (Module 4)